

ON Semiconductor®

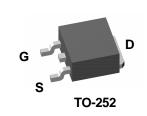
FDD6630A 30V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

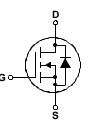
Applications

- DC/DC converter
- Motor drives



Features

- 21 A, 30 V $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge (5nC typical)
- · Fast switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
l _D	Drain Current – Continuous	(Note 3)	21	A
	- Pulsed	(Note 1a)	100	
P _D	Power Dissipation	(Note 1)	28	W
		(Note 1a)	3.2	
		(Note 1b)	1.3	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Characteristics			
Reic	Thermal Resistance, Junction-to-Case	(Note 1)	4.5	°C/W

I NOJ C		(NOLE I)	4.5	0/11
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

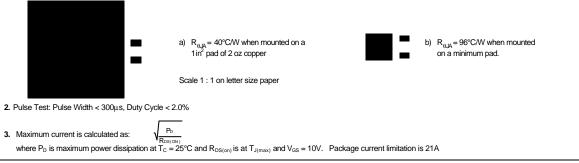
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD6630A	FDD6630A	13"	16mm	2500 units

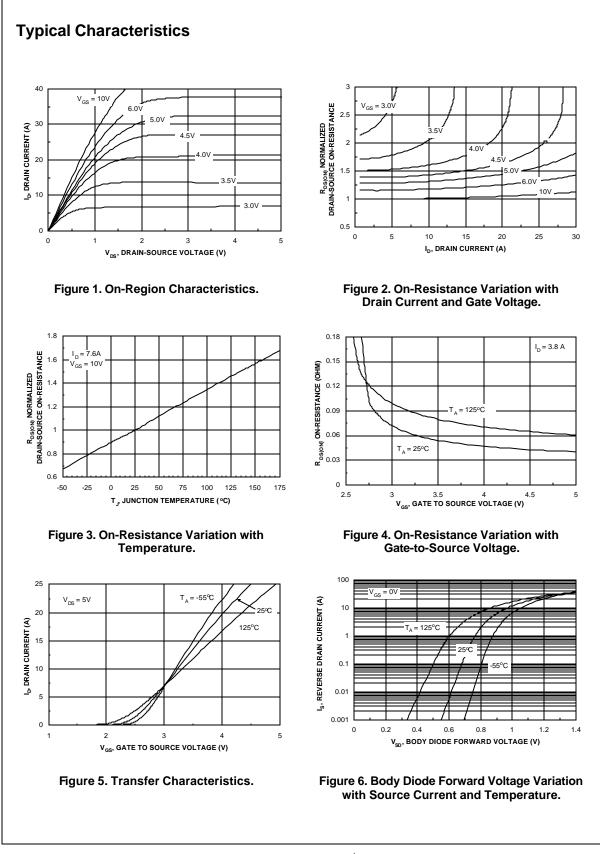
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	Parameter	Test Conditions	Min	Тур	Max	Units
	urce Avalanche Ratings (Note	2)	1	1		
	Drain-Source Avalanche Energy	Single Pulse, V _{DD} = 15 V			55	mJ
AR	Drain-Source Avalanche Current	5 2 2			7.6	А
	acteristics					
	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
	Breakdown Voltage Temperature	$I_D = 250 \mu$ A, Referenced to 25°C		23		mV/ºC
ΔT_{J}	Coefficient					
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	1.7	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-4		mV/ºC
R _{DS(on)}	Static Drain–Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.6 \text{ A}$		28	35	mΩ
	On-Resistance	$V_{GS} = 4.5 V, I_D = 6.3 A$ $V_{GS} = 10 V, I_D = 7.6 A, T_J = 125^{\circ}C$		40 44	50 58	
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	20			Α
ĴFS	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 7.6 A$		13		S
Dvnamic	Characteristics		l	l		
-	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		462		pF
Coss	Output Capacitance	f = 1.0 MHz		113		pF
	Reverse Transfer Capacitance			40		pF
	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		5	11	ns
tr	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		8	17	ns
	Turn–Off Delay Time			17	28	ns
- (-)	Turn–Off Fall Time			13	24	ns
	Total Gate Charge	$V_{DS} = 15 V$, $I_D = 7.6 A$,		5	7	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		2		nC
Q _{gd}	Gate-Drain Charge			1.4		nC
0	ource Diode Characteristics	and Maximum Patings				110
	Maximum Continuous Drain–Source				2.7	Δ
s V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_S = 2.7 \text{ A}$ (Note 2)		0.8	1.2	A V

FDD6630A

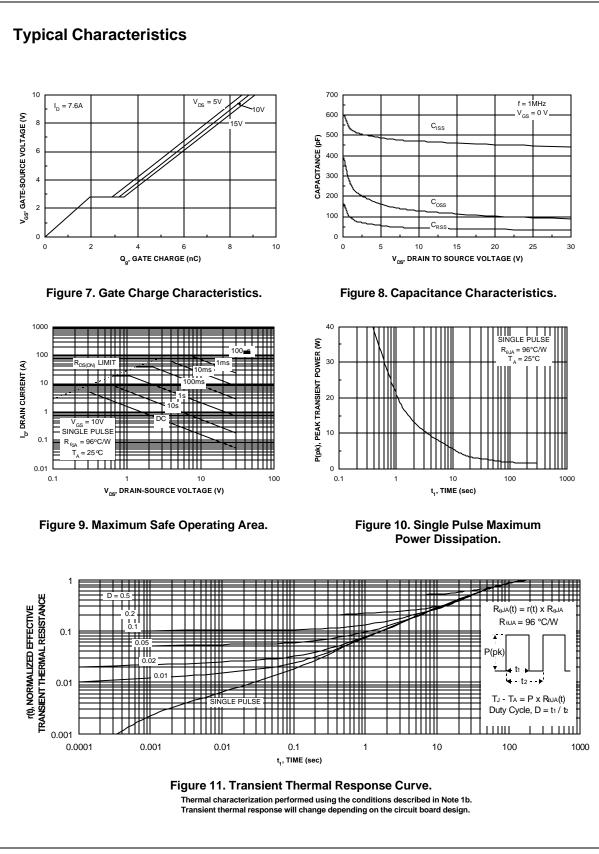


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